

LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT

SERIAL (		10/015 : <u>Hyjng-</u>	Jun KIM			cember 17, 2001 arch 3, 2003
*****	****	*****	*****	******	<b>****</b>	******
			U.S. PAT	ENT DOCUMENTS	T NT(T) / T	CLTD .
*EXAMINER INITIAL		DOCUMENT <u>NUMBER</u>	DATE	NAME	INT'L <u>CLASS</u>	SUB- FILING DATE  CLASS (If Appropriate)
	.AA					
	74 175					
	AB					
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			FOREIGN P.	ATENT DOCUMENTS		
		DOCUMENT NUMBER	DATE	COUNTRY	INT'L <u>CLASS</u>	SUB- TRANSLATION CLASS (YES) (NO)
MC	AC	11-142871	05/28/99	JAPAN	<u>G02F</u>	1/1343 X
M L	AD	03-171735	07/25/91	JAPAN	<u> H01L</u>	21/3205 X
ML	AE	04-096343	03/27/92	JAPAN	<u>H01L</u>	21/66 X
ML	AF	05-055218	03/05/93	JAPAN	<u>H01L</u>	21/3205 X
*****	****	*****	*****	*****	*****	******
	OTHER	ART (Includ	ing Author,	Title, Date, Per	rtinent P	ages, Etc.)
	AG					
	AH					
		$ \gamma$ $\gamma$				
EXAMINER /	/ /			DATE CONSIDERED	166	
* EXAMINER;	Initia	lif reference consi	$\overline{}$		104	